

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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**5 V, SUPER MINIMOLD SILICON MMIC WIDEBAND AMPLIFIER**

**DESCRIPTION**

The  $\mu$ PC3215TB is a silicon monolithic IC designed as wideband amplifier. The  $\mu$ PC3215TB is suitable to systems required wideband operation from HF to L band.

This IC is manufactured using NEC's 30 GHz  $f_{max}$  UHS0 (Ultra High Speed Process) silicon bipolar process. The package is 6-pin super minimold suitable for surface mount.

**FEATURES**

- Wideband response :  $f_u = 2.9$  GHz TYP. @3 dB bandwidth
- Noise figure : NF = 2.3 dB TYP. @f = 1.5 GHz
- Power gain :  $G_P = 20.5$  dB TYP. @f = 1.5 GHz
- Supply voltage :  $V_{cc} = 4.5$  to 5.5 V
- High-density surface mounting: 6-pin super minimold package

**APPLICATION**

- Systems required wideband operation from HF to L band

**ORDERING INFORMATION**

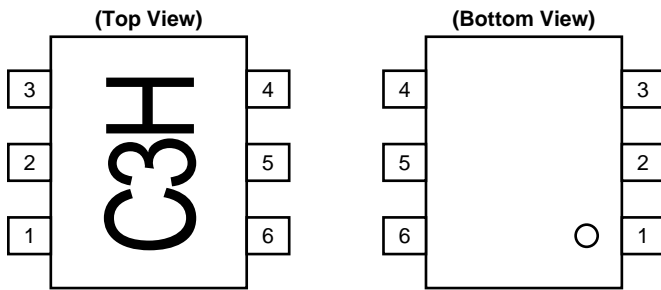
| Part Number       | Package              | Marking | Supplying Form  |
|-------------------|----------------------|---------|---|
| $\mu$ PC3215TB-E3 | 6-pin super minimold | C3H     | Embossed tape 8 mm wide.<br>1, 2, 3 pins face the perforation side of the tape.<br>Qty 3 kpcs/reel. |

**Remark** To order evaluation samples, please contact your local NEC sales office. (Part number for sample order:  $\mu$ PC3215TB)

**Caution Electro-static sensitive devices**

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

**PIN CONNECTIONS**



| Pin No. | Pin Name        |
|---------|-----------------|
| 1       | INPUT           |
| 2       | GND             |
| 3       | GND             |
| 4       | OUTPUT          |
| 5       | GND             |
| 6       | V <sub>CC</sub> |

**PRODUCT LINE-UP OF 5V-BIAS SILICON MMIC WIDEBAND AMPLIFIERS**

(T<sub>A</sub> = +25°C, V<sub>CC</sub> = 5.0 V, Z<sub>S</sub> = Z<sub>L</sub> = 50 Ω)

| Part No.       | f <sub>u</sub><br>(GHz) | P <sub>O (sat)</sub><br>(dBm) | G <sub>P</sub><br>(dB) | NF<br>(dB)          | I <sub>CC</sub><br>(mA) | Package              | Marking |
|----------------|-------------------------|-------------------------------|------------------------|---------------------|-------------------------|----------------------|---------|
| $\mu$ PC2711T  | 2.9                     | +1.0                          | 13                     | 5.0<br>@f = 1 GHz   | 12                      | 6-pin minimold       | C1G     |
| $\mu$ PC2711TB |                         |                               |                        |                     |                         | 6-pin super minimold |         |
| $\mu$ PC2712T  | 2.6                     | +3.0                          | 20                     | 4.5<br>@f = 1 GHz   | 12                      | 6-pin minimold       | C1H     |
| $\mu$ PC2712TB |                         |                               |                        |                     |                         | 6-pin super minimold |         |
| $\mu$ PC3210TB | 2.3                     | +3.5                          | 20                     | 3.4<br>@f = 1.5 GHz | 15                      | 6-pin super minimold | C2X     |
| $\mu$ PC3215TB | 2.9                     | +3.5                          | 20.5                   | 2.3<br>@f = 1.5 GHz | 14                      | 6-pin super minimold | C3H     |

**Remark** Typical performance. Please refer to ELECTRICAL CHARACTERISTICS in detail.

**Caution** The package size distinguishes between minimold and super minimold.

**PIN EXPLANATION**

| Pin No.     | Pin Name        | Applied Voltage (V) | Pin Voltage (V) <sup>Note</sup> | Function and Applications  | Internal Equivalent Circuit |
|-------------|-----------------|---------------------|---------------------------------|--|-----------------------------|
| 1           | INPUT           | —                   | 0.82                            | Signal input pin. A internal matching circuit, configured with resistors, enables 50 $\Omega$ connection over a wideband. A multi-feedback circuit is designed to cancel the deviations of $h_{FE}$ and resistance. This pin must be coupled to signal source with capacitor for DC cut. |                             |
| 2<br>3<br>5 | GND             | 0                   | —                               | Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible. All the ground pins must be connected together with wide ground pattern to decrease impedance difference.                           |                             |
| 4           | OUTPUT          | —                   | 3.8                             | Signal output pin. A internal matching circuit, configured with resistors, enables 50 $\Omega$ connection over a wideband. This pin must be coupled to next stage with capacitor for DC cut.   |                             |
| 6           | V <sub>CC</sub> | 4.5 to 5.5          | —                               | Power supply pin. This pin should be externally equipped with bypass capacitor to minimize ground impedance.   |                             |

**Note** Pin voltage is measured at V<sub>CC</sub> = 5.0 V

**ABSOLUTE MAXIMUM RATINGS**

| Parameter                     | Symbol    | Conditions                              | Ratings     | Unit             |
|-------------------------------|-----------|---|-------------|------------------|
| Supply Voltage                | $V_{CC}$  | $T_A = +25^\circ\text{C}$               | 6.0         | V                |
| Circuit Current               | $I_{CC}$  | $T_A = +25^\circ\text{C}$               | 30          | mA               |
| Input Power                   | $P_{in}$  | $T_A = +25^\circ\text{C}$               | +10         | dBm              |
| Power Dissipation             | $P_D$     | $T_A = +85^\circ\text{C}^{\text{Note}}$ | 270         | mW               |
| Operating Ambient Temperature | $T_A$     |   | -40 to +85  | $^\circ\text{C}$ |
| Storage Temperature           | $T_{stg}$ |   | -55 to +150 | $^\circ\text{C}$ |

**Note** Mounted on  $50 \times 50 \times 1.6$ -mm epoxy glass PWB, with copper patterning on both sides.

**RECOMMENDED OPERATING CONDITIONS**

| Parameter                     | Symbol   | MIN. | TYP. | MAX. | Unit             |
|-------------------------------|----------|------|------|------|------------------|
| Supply Voltage                | $V_{CC}$ | 4.5  | 5.0  | 5.5  | V                |
| Operating Ambient Temperature | $T_A$    | -40  | +25  | +85  | $^\circ\text{C}$ |
| Input Power                   | $P_{in}$ | -    | -    | 0    | dBm              |
| Input Frequency               | $f_{in}$ | 0.1  | -    | 2.9  | GHz              |

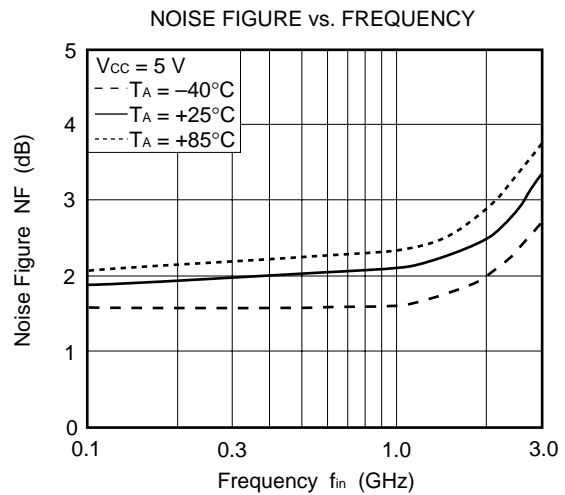
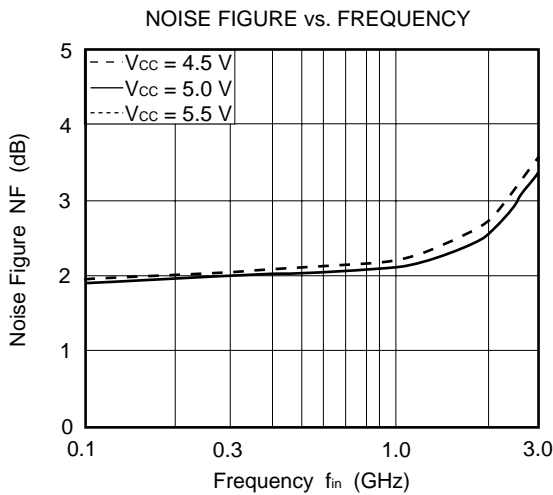
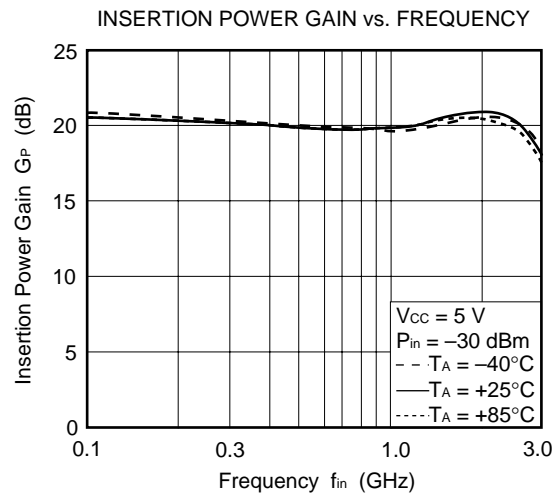
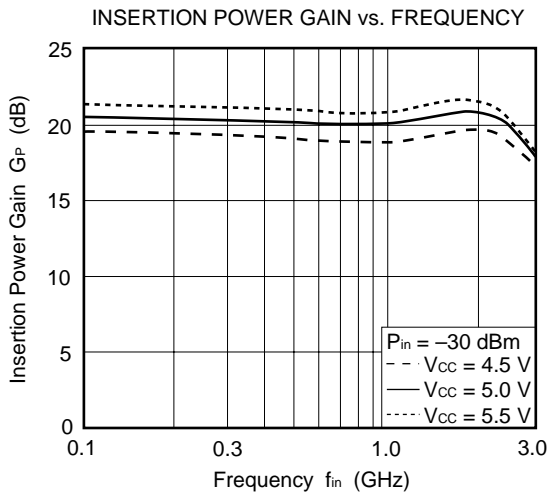
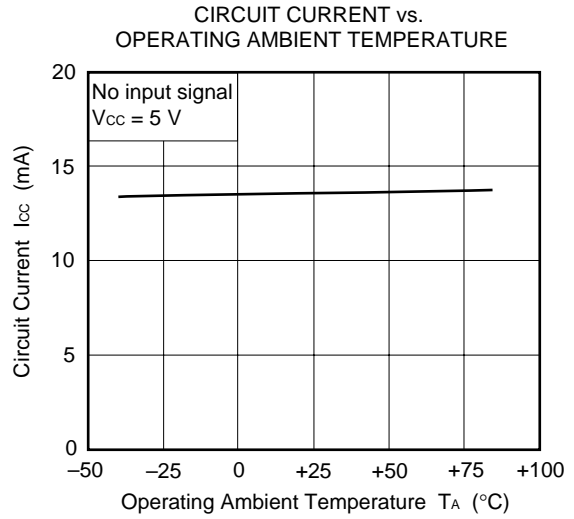
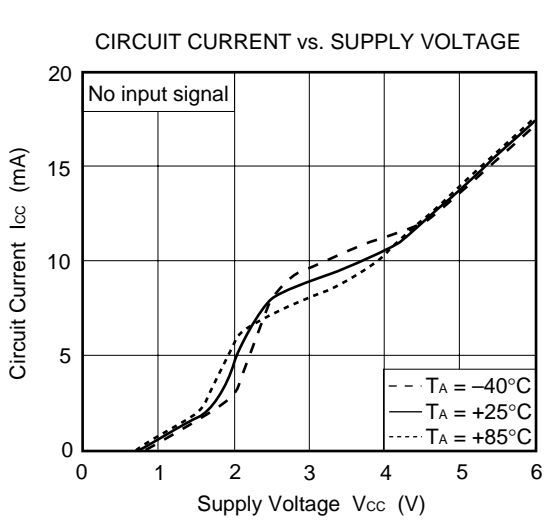
**ELECTRICAL CHARACTERISTICS ( $T_A = +25^\circ\text{C}$ ,  $V_{CC} = 5.0\text{ V}$ ,  $Z_s = Z_L = 50\ \Omega$ )**

| Parameter                       | Symbol     | Test Conditions                                   | MIN. | TYP. | MAX. | Unit |
|---------------------------------|------------|---|------|------|------|------|
| Circuit Current                 | $I_{CC}$   | No input signals                                  | 10.5 | 14.0 | 17.5 | mA   |
| Power Gain                      | $G_P$      | $f = 1.5\text{ GHz}$ , $P_{in} = -30\text{ dBm}$  | 18.5 | 20.5 | -    | dB   |
| Noise Figure                    | NF         | $f = 1.5\text{ GHz}$                              | -    | 2.3  | 3.0  | dB   |
| Upper Limit Operating Frequency | $f_u$      | 3 dB down below from gain at $f = 0.1\text{ GHz}$ | 2.5  | 2.9  | -    | GHz  |
| Isolation                       | ISL        | $f = 1.5\text{ GHz}$ , $P_{in} = -30\text{ dBm}$  | 39   | 44   | -    | dB   |
| Input Return Loss               | $RL_{in}$  | $f = 1.5\text{ GHz}$ , $P_{in} = -30\text{ dBm}$  | 10   | 15   | -    | dB   |
| Output Return Loss              | $RL_{out}$ | $f = 1.5\text{ GHz}$ , $P_{in} = -30\text{ dBm}$  | 6.5  | 9.5  | -    | dB   |
| 1 dB Compression Point          | P-1        |   | -4   | -1.5 | -    | dBm  |

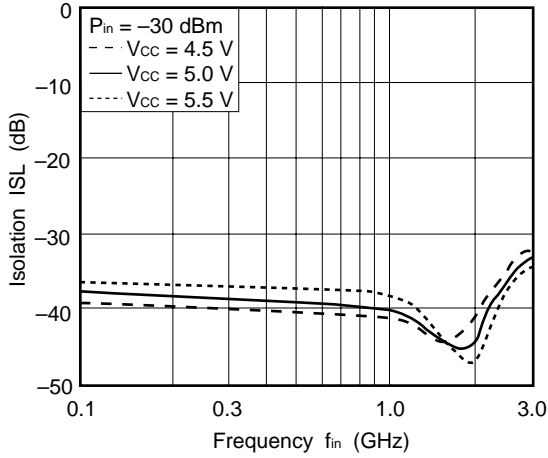
**STANDARD CHARACTERISTICS ( $T_A = +25^\circ\text{C}$ ,  $V_{CC} = 5.0\text{ V}$ ,  $Z_s = Z_L = 50\ \Omega$ )**

| Parameter              | Symbol       | Test Conditions                                   | Reference Values | Unit |
|------------------------|--------------|---|------------------|------|
| Saturated Output Power | $P_{O(sat)}$ | $P_{in} = 0\text{ dBm}$                           | +3.5             | dBm  |
| Output Intercept Point | $OIP_3$      | $f_1 = 1.5\text{ GHz}$ , $f_2 = 1.501\text{ GHz}$ | +10              | dBm  |
| Gain Flatness          | $\Delta G_P$ | $f = 0.1\text{ to }2.15\text{ GHz}$               | 1.0              | dB   |

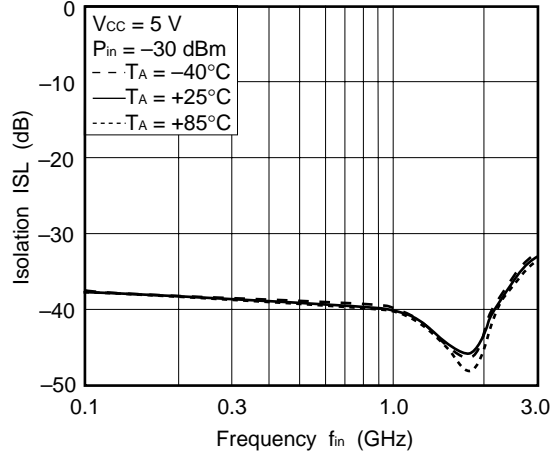
★ TYPICAL CHARACTERISTICS (Unless otherwise specified,  $T_A = +25^\circ\text{C}$ )



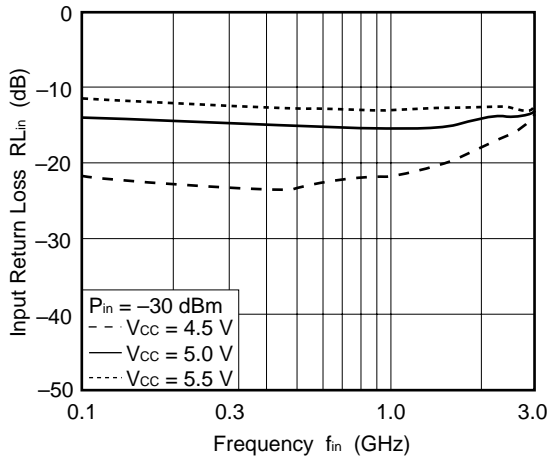
ISOLATION vs. FREQUENCY



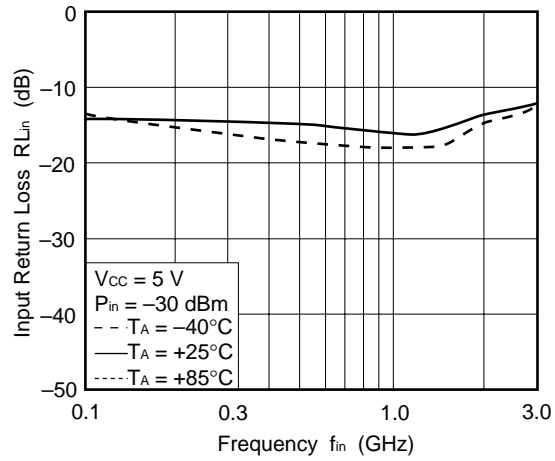
ISOLATION vs. FREQUENCY



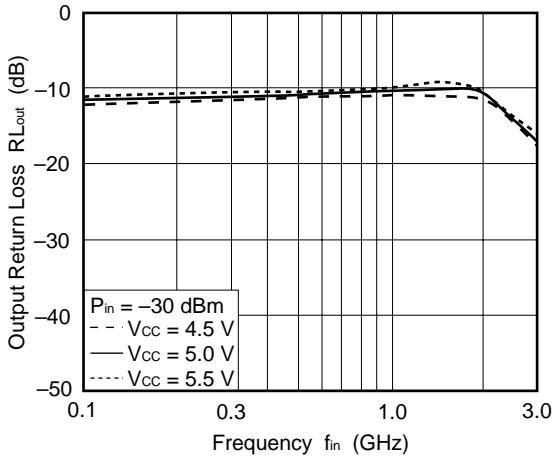
INPUT RETURN LOSS vs. FREQUENCY



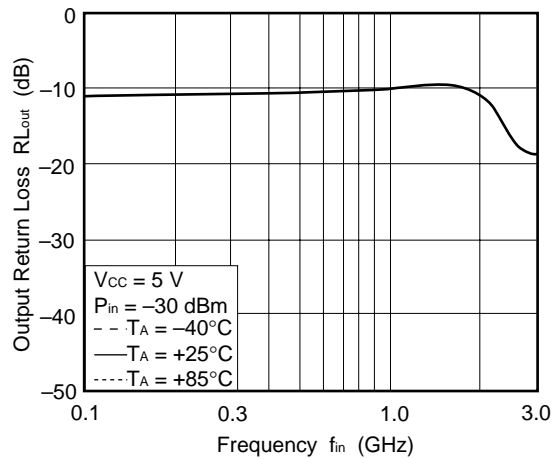
INPUT RETURN LOSS vs. FREQUENCY



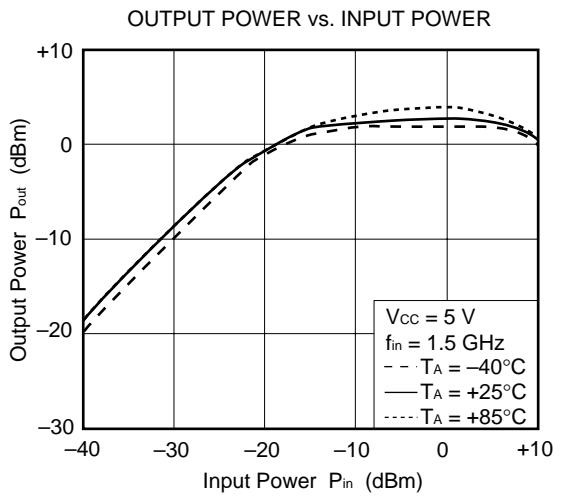
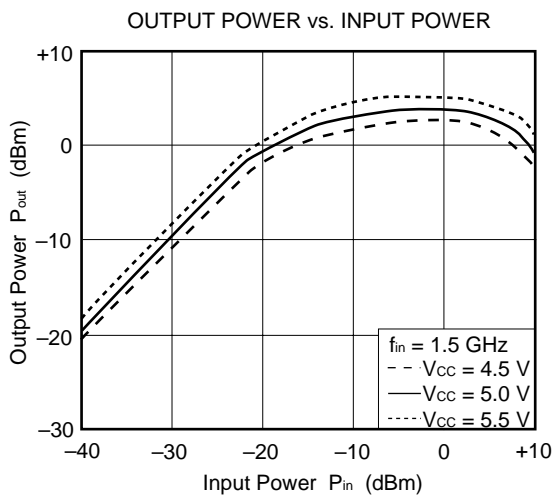
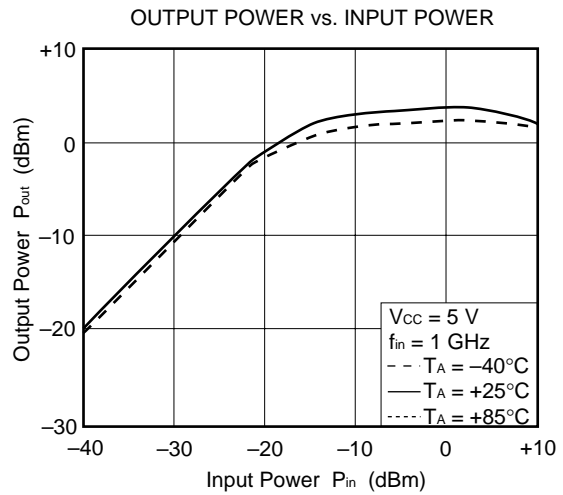
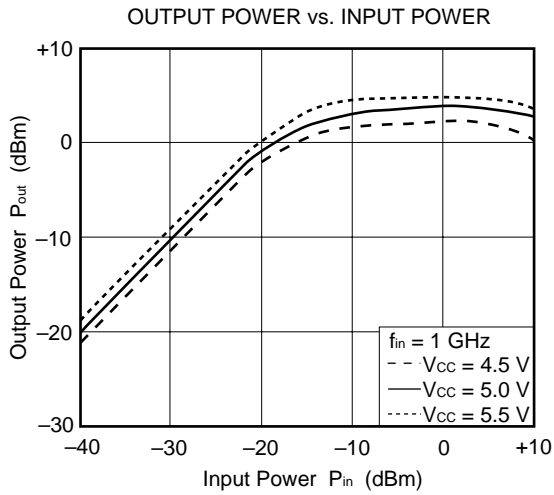
OUTPUT RETURN LOSS vs. FREQUENCY

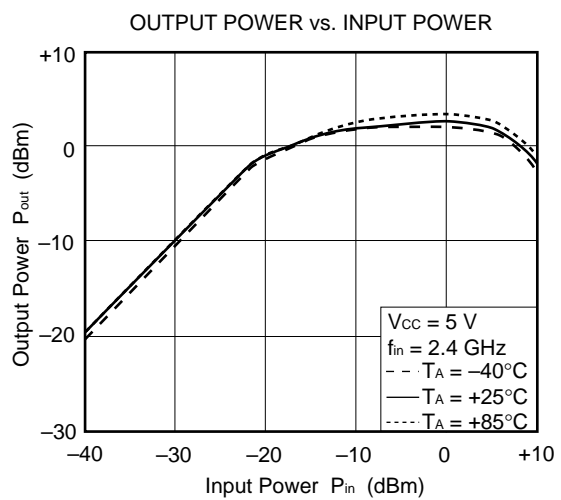
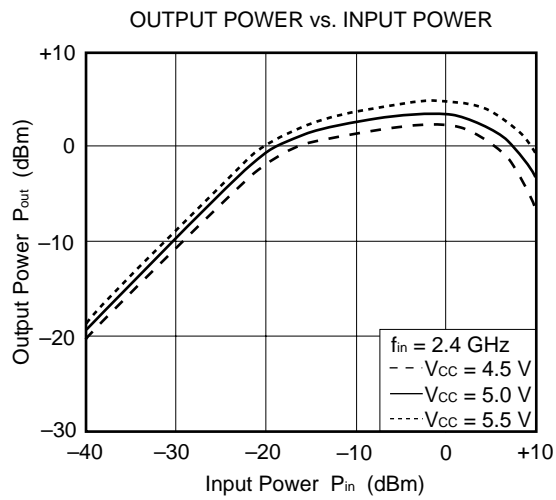
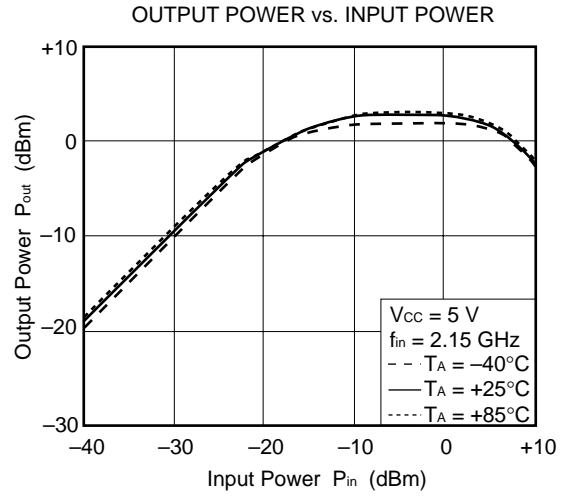
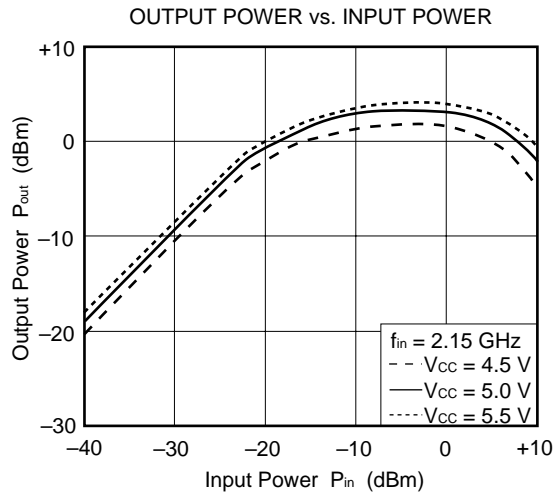


OUTPUT RETURN LOSS vs. FREQUENCY

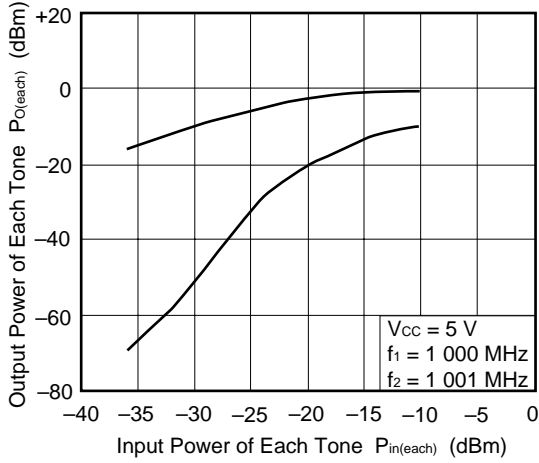




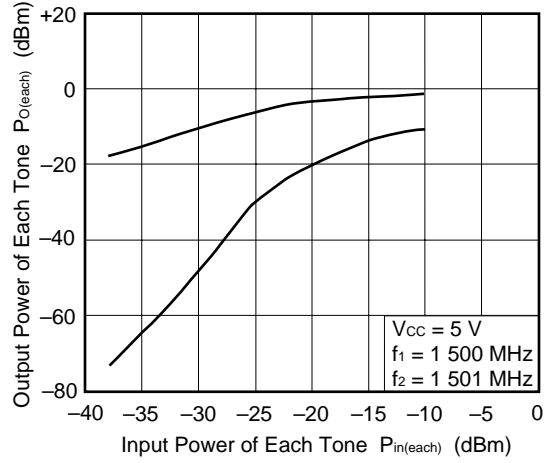




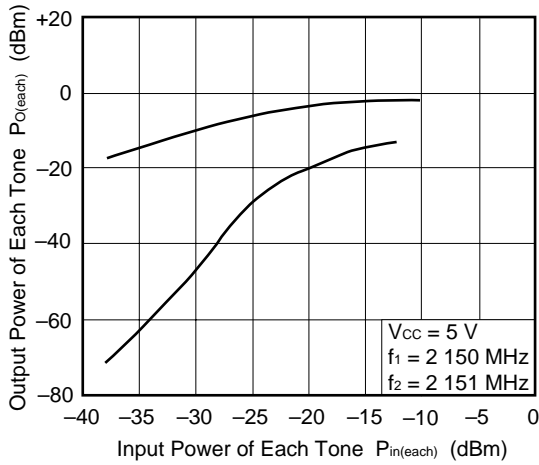
OUTPUT POWER OF EACH TONE vs.  
INPUT POWER OF EACH TONE



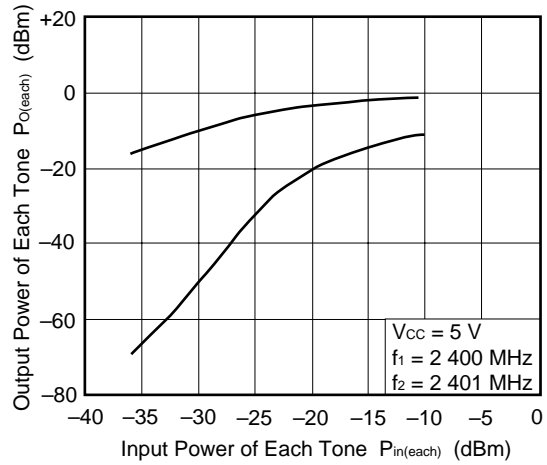
OUTPUT POWER OF EACH TONE vs.  
INPUT POWER OF EACH TONE



OUTPUT POWER OF EACH TONE vs.  
INPUT POWER OF EACH TONE



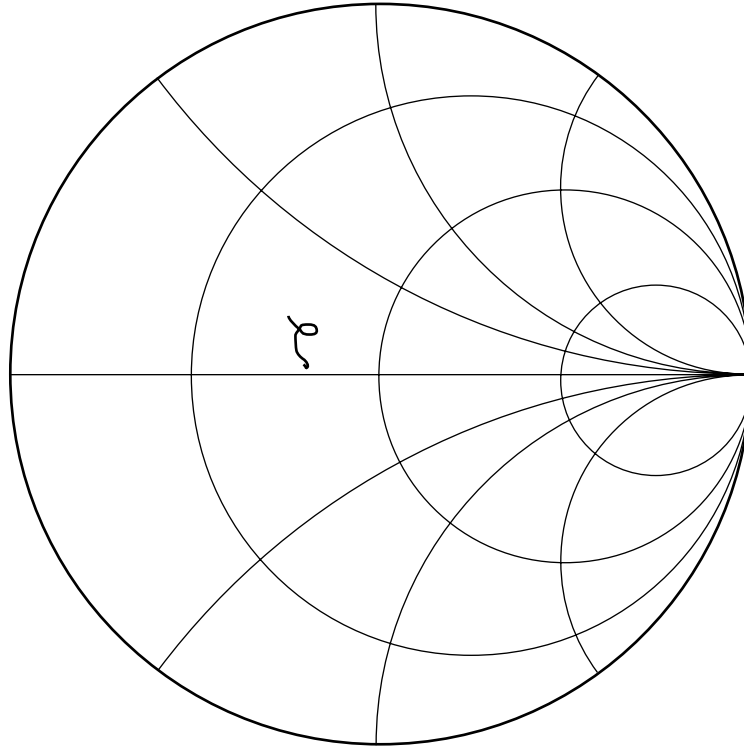
OUTPUT POWER OF EACH TONE vs.  
INPUT POWER OF EACH TONE



**Remark** The graphs indicate nominal characteristics.

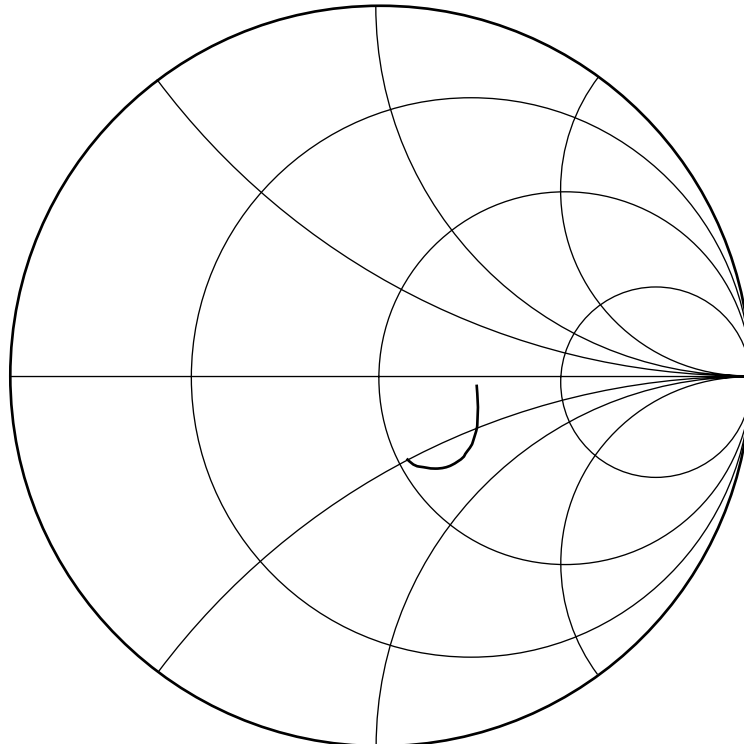
★ S-PARAMETERS ( $T_A = +25^\circ\text{C}$ ,  $V_{CC} = 5\text{ V}$ )

S<sub>11</sub>-FREQUENCY



START 0.10000000 GHz  
STOP 3.10000000 GHz

S<sub>22</sub>-FREQUENCY



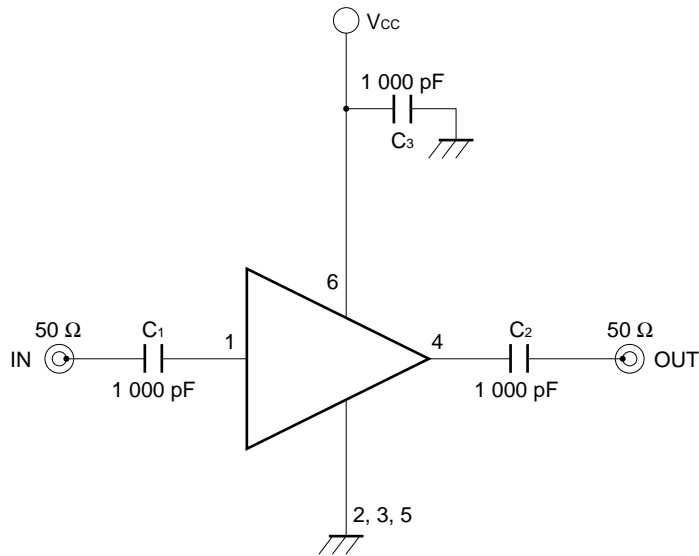
START 0.10000000 GHz  
STOP 3.10000000 GHz

★ TYPICAL S-PARAMETER VALUES (T<sub>A</sub> = +25°C)

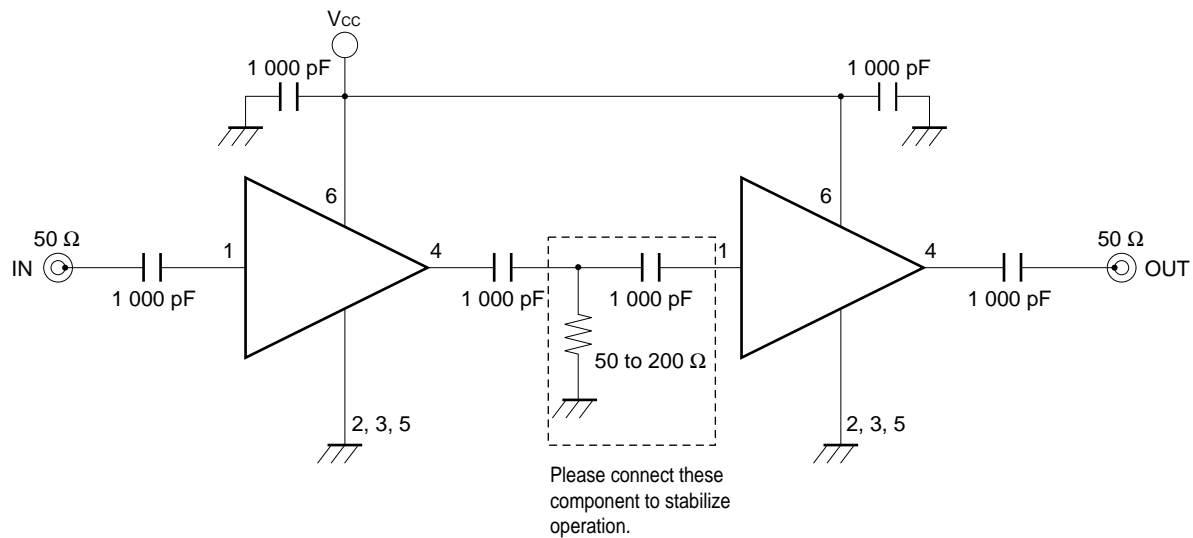
V<sub>CC</sub> = 5.0 V, I<sub>CC</sub> = 16 mA

| FREQUENCY<br>MHz | S <sub>11</sub> |       | S <sub>21</sub> |        | S <sub>12</sub> |       | S <sub>22</sub> |       | K     |
|------------------|-----------------|-------|-----------------|--------|-----------------|-------|-----------------|-------|-------|
|                  | MAG.            | ANG.  | MAG.            | ANG.   | MAG.            | ANG.  | MAG.            | ANG.  |       |
| 100.0000         | 0.207           | 174.1 | 10.788          | -4.6   | 0.013           | 6.3   | 0.285           | -3.3  | 3.38  |
| 200.0000         | 0.190           | 173.1 | 10.714          | -9.8   | 0.013           | -0.5  | 0.282           | -3.7  | 3.39  |
| 300.0000         | 0.186           | 174.3 | 10.565          | -14.3  | 0.013           | 2.7   | 0.283           | -4.6  | 3.37  |
| 400.0000         | 0.192           | 173.8 | 10.359          | -18.3  | 0.014           | 4.7   | 0.285           | -6.2  | 3.92  |
| 500.0000         | 0.200           | 174.5 | 10.225          | -21.7  | 0.013           | 5.3   | 0.286           | -7.6  | 3.96  |
| 600.0000         | 0.201           | 173.0 | 10.116          | -24.9  | 0.013           | 2.1   | 0.286           | -8.8  | 3.69  |
| 700.0000         | 0.204           | 173.0 | 10.116          | -28.0  | 0.011           | 1.6   | 0.288           | -10.4 | 3.91  |
| 800.0000         | 0.206           | 172.4 | 10.122          | -31.1  | 0.011           | 12.9  | 0.289           | -11.7 | 4.17  |
| 900.0000         | 0.210           | 172.7 | 10.186          | -34.5  | 0.011           | 5.1   | 0.290           | -13.5 | 3.99  |
| 1000.0000        | 0.212           | 171.4 | 10.182          | -37.7  | 0.009           | 4.1   | 0.295           | -14.9 | 4.28  |
| 1100.0000        | 0.218           | 169.4 | 10.208          | -41.6  | 0.011           | 4.9   | 0.299           | -16.8 | 4.19  |
| 1200.0000        | 0.217           | 168.4 | 10.296          | -45.6  | 0.009           | 11.0  | 0.300           | -18.0 | 4.65  |
| 1300.0000        | 0.221           | 165.9 | 10.248          | -49.7  | 0.006           | 20.5  | 0.299           | -20.2 | 5.78  |
| 1400.0000        | 0.228           | 164.7 | 10.438          | -53.9  | 0.008           | 1.6   | 0.307           | -23.1 | 6.97  |
| 1500.0000        | 0.233           | 162.3 | 10.369          | -58.0  | 0.006           | 25.7  | 0.310           | -24.8 | 6.80  |
| 1600.0000        | 0.238           | 159.5 | 10.554          | -62.7  | 0.005           | 31.6  | 0.316           | -27.5 | 11.54 |
| 1700.0000        | 0.244           | 157.2 | 10.492          | -67.2  | 0.004           | 48.5  | 0.317           | -30.5 | 11.75 |
| 1800.0000        | 0.246           | 153.9 | 10.483          | -72.2  | 0.003           | 87.2  | 0.318           | -33.3 | 13.52 |
| 1900.0000        | 0.248           | 150.6 | 10.408          | -76.9  | 0.004           | 93.4  | 0.323           | -36.9 | 8.46  |
| 2000.0000        | 0.246           | 147.4 | 10.405          | -82.2  | 0.007           | 114.5 | 0.323           | -40.6 | 7.46  |
| 2100.0000        | 0.241           | 144.9 | 10.267          | -87.2  | 0.008           | 115.4 | 0.319           | -44.9 | 6.20  |
| 2200.0000        | 0.236           | 142.2 | 10.039          | -92.7  | 0.011           | 124.0 | 0.312           | -48.9 | 4.50  |
| 2300.0000        | 0.229           | 142.2 | 9.896           | -97.7  | 0.012           | 121.6 | 0.306           | -52.6 | 4.12  |
| 2400.0000        | 0.219           | 143.5 | 9.684           | -102.4 | 0.014           | 124.9 | 0.292           | -56.3 | 3.40  |
| 2500.0000        | 0.215           | 145.7 | 9.348           | -107.5 | 0.015           | 117.8 | 0.279           | -59.3 | 3.42  |
| 2600.0000        | 0.213           | 149.3 | 9.068           | -112.0 | 0.018           | 117.3 | 0.270           | -61.7 | 3.02  |
| 2700.0000        | 0.221           | 150.1 | 8.673           | -116.6 | 0.017           | 114.4 | 0.256           | -63.7 | 3.17  |
| 2800.0000        | 0.234           | 151.3 | 8.437           | -121.1 | 0.020           | 114.0 | 0.248           | -65.1 | 2.85  |
| 2900.0000        | 0.253           | 152.1 | 8.080           | -124.9 | 0.021           | 111.6 | 0.237           | -67.3 | 2.98  |
| 3000.0000        | 0.264           | 150.7 | 7.791           | -129.4 | 0.020           | 112.5 | 0.232           | -68.0 | 2.90  |
| 3100.0000        | 0.283           | 148.7 | 7.458           | -132.7 | 0.022           | 113.7 | 0.229           | -70.2 | 3.02  |

TEST CIRCUIT



EXAMPLE OF APPLICATION CIRCUIT



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

Capacitors for Vcc, input and output pins

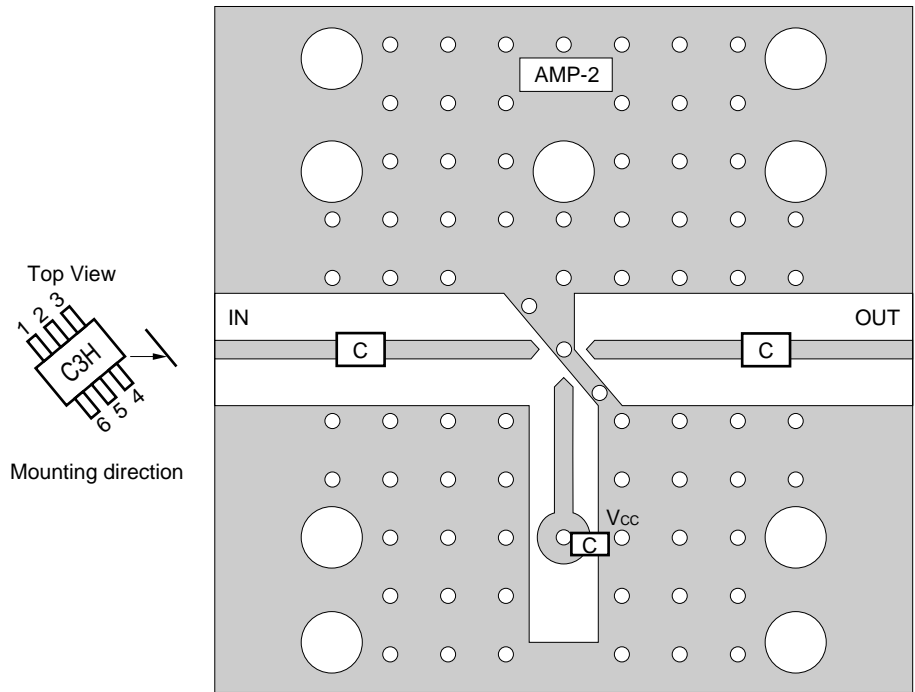
1 000 pF capacitors are recommendable as bypass capacitor for Vcc pin and coupling capacitors for input/output pins.

Bypass capacitor for Vcc pin is intended to minimize Vcc pin's ground impedance. Therefore, stable bias can be supplied against Vcc fluctuation.

Coupling capacitors for input/output pins are intended to minimize RF serial impedance and cut DC.

To get flat gain from 100 MHz up, 1 000 pF capacitors are assembled on the test circuit. [Actually, 1 000 pF capacitors give flat gain at least 10 MHz. In the case of under 10 MHz operation, increase the value of coupling capacitor such as 2 200 pF. Because the coupling capacitors are determined by the equation of  $C = 1/(2 \pi fZ_s)$ .]

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



COMPONENT LIST

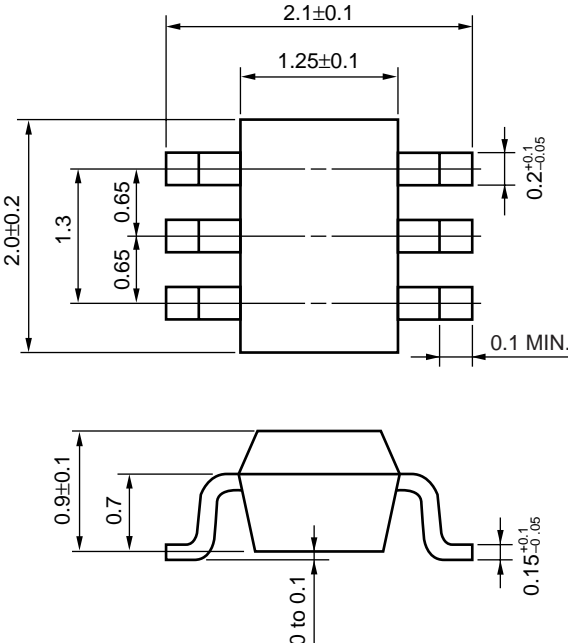
|   | Value    |
|---|----------|
| C | 1 000 pF |

Notes

1. 30 × 30 × 0.4 mm double sided copper clad polyimide board.
2. Back side: GND pattern
3. Solder plated on pattern
4. ○ ○ : Through holes

PACKAGE DIMENSIONS

★ 6-PIN SUPER MINIMOLD (UNIT: mm)





**NOTES ON CORRECT USE**

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation).
- (3) Keep the track length of the ground pins as short as possible.
- (4) A low pass filter must be attached to Vcc line.

**RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your NEC sales representative.

| Soldering Method | Soldering Conditions  | Recommended Condition Symbol |
|------------------|---|------------------------------|
| Infrared Reflow  | Package peak temperature: 235°C or below<br>Time: 30 seconds or less (at 210°C)<br>Count: 3, Exposure limit: None <sup>Note</sup> | IR35-00-3                    |
| VPS              | Package peak temperature: 215°C or below<br>Time: 40 seconds or less (at 200°C)<br>Count: 3, Exposure limit: None <sup>Note</sup> | VP15-00-3                    |
| Wave Soldering   | Soldering bath temperature: 260°C or below<br>Time: 10 seconds or less<br>Count: 1, Exposure limit: None <sup>Note</sup>          | WS60-00-1                    |
| Partial Heating  | Pin temperature: 300°C<br>Time: 3 seconds or less (per side of device)<br>Exposure limit: None <sup>Note</sup>                    | —                            |

**Note** After opening the dry pack, keep it in a place below 25°C and 65% RH for the allowable storage period.

**Caution** Do not use different soldering methods together (except for partial heating).

For details of recommended soldering conditions for surface mounting, refer to information document SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535E).

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